

MYPro series MY300HX™

pick-and-place

Specifications
March 2022



Specifications MYPro series **MY300HX™**

PLACEMENT SPEED AND ACCURACY	
MY300HX-9/13	
Rated speed ⁽¹⁾	45,000 CPH
IPC 9850 chip net throughput ^(2, 3)	33,000 CPH
IPC 9850 chip tact time ⁽³⁾	0.097s
IPC 9850 chip repeatability 3σ (X, Y, Theta) ⁽³⁾	30μm, 1.8° ⁽⁵⁾ 45μm, 1.8°
IPC 9850 chip accuracy @ Cpk = 1.33 (X, Y, Theta) ⁽⁴⁾	50μm, 2.6° ⁽⁵⁾ 75μm, 2.6°

The IPC 9850 net throughput and accuracy numbers are obtained simultaneously, with the same machine settings.The rated speed value is obtained under conditions optimized for speed.

(1) Optimal conditions.
(2) According to IPC 9850. Net throughput = (no of parts x 3,600)/(board build time + board transfer time).
(3) According to IPC 9850 0402C verification panel.
(4) According to IPC 9850 Cpk 1.33 = 4σ + offset.
(5) Small chip settings, recommended for 0201 (0.6 x 0.3 mm) and below.

SYSTEM FEATURES
MY300HX
On-the-fly mount order optimization
Vision autoteach with snap-to-grid
Automatic illumination settings
Intelligent feeder concept—Agilis
Automatic feeder and component recognition
On-the-fly feeder loading
Dynamic feeder positions
Automatic board stretch compensation
Automatic conveyor width adjustment
Tool collision avoidance
Multi-user, multi-tasking system software
Open software interfaces for factory integration
SQL database engine
Programmable light settings fiducial camera

COMPONENT RANGE	
HIGH SPEED MOUNTHEAD—HYDRA Z8	
Component range	Chip (from 01005), SO28, SOT223, SOJ20, PLCC32, MELF, SOD, TSOP
Component specification	Min: 0.4 x 0.2mm (0.016 x 0.008”) (01005) Max: 18.6 x 18.6 x 5.60mm (0.73 x 0.73 x 0.22”) (PLCC44)

ELECTRICAL VERIFIER (OPTIONAL)	
Component range	Resistor, capacitor, unipolar capacitor, diode (forward voltage, reverse current), Zener diode (reverse voltage), bipolar transistor (current gain), FET/IGBT (gate threshold voltage). Smallest chip size 1.0 x 0.5 mm (0.04 x 0.02”).

FEEDER CAPACITY		
8 MM TAPE	T460	T640
MY300HX-9	96	N/A
MY300HX-13	160	144

BOARD HANDLING		
INLINE CONVEYOR	T460	T640
Maximum board size	460 x 510mm (18 x 20”)	640 x 510mm (25 x 20”)
Minimum board size ⁽¹⁾	70 x 50mm (2.7 x 2”)	70 x 50mm (2.7 x 2”)
Maximum board train length	436mm (17.1”)	472mm (18.5”)
Board thickness range ⁽¹⁾	0.4–6.0mm (0.016–0.24”)	0.4–6.0mm (0.016–0.24”)
Board edge clearance top	3.2mm (0.13”)	3.2mm (0.13”)
Board edge clearance bottom ⁽²⁾	3.2mm (0.13”)	3.2mm (0.13”)
Top side clearance (max)	5.6mm (0.22”)	5.6mm (0.22”)
Bottom side clearance (max) ⁽³⁾	32mm (1.25”)	32mm (1.25”)
Maximum board weight	4kg (8.8lbs)	4kg (8.8lbs)
Board transfer height	Conforms to SMEMA standard for board transfer height. Height adjustable from 880 to 975mm (34.6 to 38.4”).	
Operation mode	Inline, manual, inline odd-board, left-to-right / right-to-left.	

(1) Board train specification: 90 x 50mm (3.5 x 2”) min board size, 1.6mm (0.06”) min thickness. Max warpage 1mm (0.04”).
(2) Edge clearance 5.5mm (0.22”) if component taller than 6mm (0.24”). 14.3mm (0.56”) if taller than 19mm (0.75”).
(3) 15mm (0.59”) with support pins.

VISION CAPABILITY		
LINESCAN VISION SYSTEM—2K RESOLUTION		
Component type	Minimum pitch	Minimum lead width
Leaded components	0.20mm (8mil)	0.10mm (4mil)
Bumped components	0.25mm (10mil)	0.13mm (5mil)

SOFTWARE
SOFTWARE MODULES (OPTIONAL)
Shared databases
Line mode
PCB ID (2D barcode)
Barcode software
PRM software

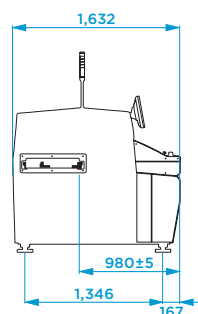
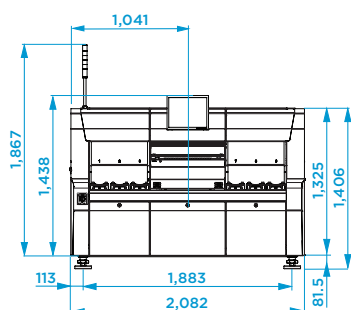
OFFLINE SOFTWARE TOOLS (OPTIONAL)
Data preparation—MYCenter
Optimization and scheduling—MYPlan
Inventory management and kitting—MYCenter
Traceability—MYTrace

MISCELLANEOUS	
INSTALLATION REQUIREMENTS	
Power requirements	Three phase AC 6.6kVA (3x2.2kVA)
Power consumption	1.5kW (average)
Voltages	3 x 200, 210, 220, 230, 240, 250 ± 10%, Y or Delta
Air supply	No air required
Noise	70dBA
Air temperature	+18 to +35°C (65 to 95°F)
Air humidity	< 95% RH non condensing

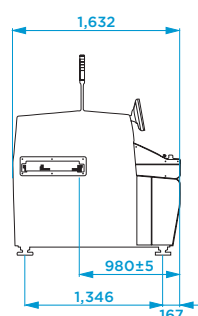
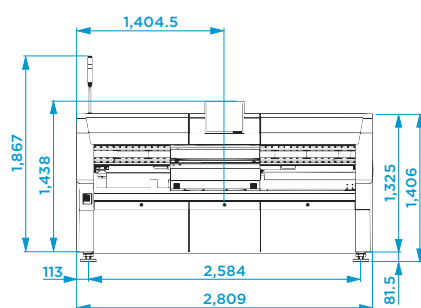
MACHINE WEIGHT ⁽¹⁾	
MY300HX-9	1,500kg (3,300lbs)
MY300HX-13	1,600kg (3,500lbs)

(1) Total machine weight excluding magazines.

DIMENSIONS	[mm]
MY300HX-9	



MY300HX-13



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